

SSM2210

FEATURES

- Very Low Voltage Noise @ 100Hz, 1nV/√Hz MAX
- Excellent Current Gain Match 0.5% TYP
- Tight V_{BE} Match (V_{OS}) 200μV MAX
- Outstanding Offset Voltage Drift 0.03μV/°C TYP
- High Gain-Bandwidth Product 200MHz TYP
- Low Cost
- Direct Replacement For LM394BN/CN

ORDERING GUIDE

Model	Temperature Range	Package Description	Package Option
SSM2210P	-40°C to +85°C	PDIP	P-8
SSM2210S	-40°C to +85°C	SOIC	S-8
SSM2210S-REEL	-40°C to +85°C	SOIC	S-8

GENERAL DESCRIPTION

The SSM2210 is a dual NPN matched transistor pair specifically designed to meet the requirements of ultra-low noise audio systems.

With its extremely low input base spreading resistance ($r_{bb'}$ is typically 28Ω), and high current gain (h_{FE} typically exceeds 600 @ $I_C = 1$ mA), systems implementing the SSM2210 can achieve outstanding signal-to-noise ratios. This will result in superior performance compared to systems incorporating commercially available monolithic amplifiers.

The equivalent input voltage noise of the SSM2210 is typically only 0.8nV/√Hz over the entire audio bandwidth of 20Hz to 20KHz.

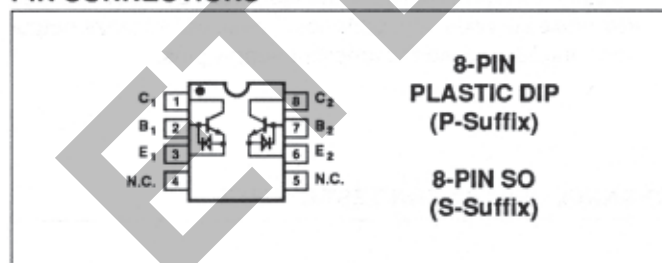
Excellent matching of the current gain (Δh_{FE}) to about 0.5% and low V_{OS} of less than 50μV (typical) make it ideal for symmetrically balanced designs which reduce high order amplifier harmonic distortion.

Stability of the matching parameters is guaranteed by protection diodes across the base-emitter junction. These diodes prevent degradation of Beta and matching characteristics due to reverse biasing of the base-emitter junction.

The SSM2210 is also an ideal choice for accurate and reliable current biasing and mirroring circuits. Furthermore, since a current mirror's accuracy degrades exponentially with mismatches of V_{BE} 's between transistor pairs, the low V_{OS} of the SSM2210 will preclude offset trimming in most circuit applications.

The SSM2210 is offered in an 8-pin epoxy DIP and 8-pin SO, its performance and characteristics are guaranteed over the extended industrial temperature range of -40°C to +85°C.

PIN CONNECTIONS



ABSOLUTE MAXIMUM RATINGS

Collector Current (I_C)	20mA
Emitter Current (I_E)	20mA
Collector-Collector Voltage (BV_{CC})	40V
Collector-Base Voltage (BV_{CBO})	40V
Collector-Emitter Voltage (BV_{CEO})	40V
Emitter-Emitter Voltage (BV_{EE})	40V
Operating Temperature Range	-40°C to +85°C
Storage Temperature	-65°C to +125°C
Junction Temperature	-65°C to +150°C
Lead Temperature (Soldering, 60 sec)	+300°C

PACKAGE TYPE	θ_{JA} (NOTE 1)	θ_{JC}	UNITS
8-Pin Plastic DIP (P)	110	50	°C/W
8-Pin SO (S)	160	44	°C/W

NOTE:

1. θ_{JA} is specified for worst case mounting conditions, i.e., θ_{JA} is specified for device in socket for P-DIP packages; θ_{JA} is specified for device soldered to printed circuit board for SO packages.

REV. C

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SSM2210

ELECTRICAL CHARACTERISTICS at $V_{CB} = 15V$, $I_C = 10\mu A$, $T_A = 25^\circ C$, unless otherwise noted.

PARAMETER	SYMBOL	CONDITIONS	SSM2210			UNITS
			MIN	TYP	MAX	
Current Gain	h_{FE}	$I_C = 1mA$ (Note 1) $I_C = 10\mu A$	300 200	605 550	— —	
Current Gain Match	Δh_{FE}	$10\mu A \leq I_C \leq 1mA$ (Note 2)	—	0.5	5	%
Noise Voltage Density	e_n	$I_C = 1mA$, $V_{CB} = 0$ (Note 3) $f_o = 10Hz$ $f_o = 100Hz$ $f_o = 1kHz$ $f_o = 10kHz$	— — — —	1.6 0.9 0.85 0.85	2 1 1 1	$nV/\sqrt{Hz}$
Offset Voltage	V_{OS}	$V_{CB} = 0$ $I_C = 1mA$	—	10	200	μV
Offset Voltage Change vs V_{CB}	$\Delta V_{OS}/\Delta V_{CB}$	$0 \leq V_{CB} \leq V_{MAX}$ (Note 4) $1\mu A \leq I_C \leq 1mA$ (Note 5)	—	10	50	μV
Offset Voltage Change vs Collector Current	$\Delta V_{OS}/\Delta I_C$	$V_{CB} = 0V$ $1\mu A \leq I_C \leq 1mA$ (Note 5)	—	5	70	μV
Breakdown Voltage	BV_{CEO}		40	—	—	V
Gain-Bandwidth Product	f_T	$I_C = 10mA$, $V_{CE} = 10V$	—	200	—	MHz
Collector-Base Leakage Current	I_{CBO}	$V_{CB} = V_{MAX}$	—	25	500	μA
Collector-Collector Leakage Current	I_{CC}	$V_{CC} = V_{MAX}$ (Notes 6, 7)	—	35	500	μA
Collector-Emitter Leakage Current	I_{CES}	$V_{CE} = V_{MAX}$ (Notes 6, 7) $V_{BE} = 0$	—	35	500	μA
Input Bias Current	I_B	$I_C = 10\mu A$	—	—	50	nA
Input Offset Current	I_{OS}	$I_C = 10\mu A$	—	—	6.2	nA
Collector Saturation Voltage	$V_{CE(SAT)}$	$I_C = 1mA$ $I_B = 100\mu A$	—	0.05	0.2	V
Output Capacitance	C_{OB}	$V_{CB} = 15V$, $I_E = 0$	—	23	—	pF
Bulk Resistance	r_{BE}	$10\mu A \leq I_C \leq 10mA$ (Note 6)	—	0.3	1.6	Ω
Collector-Collector Capacitance	C_{CC}	$V_{CC} = 0$	—	35	—	pF

NOTES:

- Current gain is guaranteed with Collector-Base Voltage (V_{CB}) swept from 0 to V_{MAX} at the indicated collector currents.
- Current Gain Match (Δh_{FE}) is defined as:

$$\Delta h_{FE} = \frac{100(\Delta I_B)(h_{FEmin})}{I_C}$$

- Noise Voltage Density is guaranteed, but not 100% tested.
- This is the maximum change in V_{OS} as V_{CB} is swept from 0V to 40V.

- Measured at $I_C = 10\mu A$ and guaranteed by design over the specified range of I_C .
- Guaranteed by design.
- I_{CC} and I_{CES} are verified by measurement of I_{CBO} .

ELECTRICAL CHARACTERISTICS at $V_{CB} = 15V$, $-40^{\circ}C \leq T_A \leq +85^{\circ}C$, unless otherwise noted.

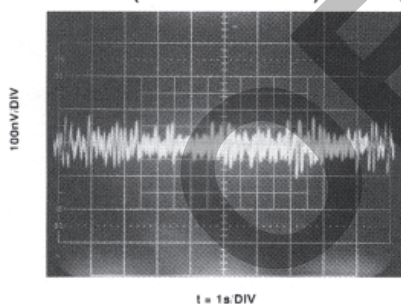
PARAMETER	SYMBOL	CONDITIONS	SSM2210			UNITS
			MIN	TYP	MAX	
Current Gain	h_{FE}	$I_C = 1mA$ (Note 1) $I_C = 10\mu A$	300 200	— —	— —	
Offset Voltage	V_{OS}	$V_{CB} = 0$ $I_C = 1mA$	—	—	220	μV
Average Offset Voltage Drift	TCV_{OS}	$10\mu A \leq I_C \leq 1mA$, $0 \leq V_{CB} \leq V_{MAX}$ (Note 2) V_{OS} Trimmed to Zero (Note 3)	— —	0.08 0.03	1 0.3	$\mu V/^{\circ}C$
Input Bias Current	I_B	$I_C = 10\mu A$	—	—	50	nA
Input Offset Current	I_{OS}	$I_C = 10\mu A$	—	—	13	nA
Input Offset Current Drift	TCI_{OS}	$I_C = 10\mu A$ (Note 4)	—	40	150	$pA/^{\circ}C$
Collector-Base Leakage Current	I_{CBO}	$V_{CB} = V_{MAX}$	—	3	—	nA
Collector-Emitter Leakage Current	I_{CES}	$V_{CE} = V_{MAX}$, $V_{BE} = 0$	—	4	—	nA
Collector-Collector Leakage Current	I_{CC}	$V_{CC} = V_{MAX}$	—	4	—	nA

NOTES:

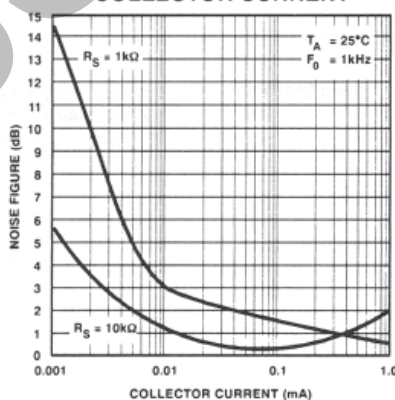
1. Current gain is guaranteed with Collector-Base Voltage (V_{CB}) swept from 0 to V_{MAX} at the indicated collector current.
2. Guaranteed by V_{OS} test ($TCV_{OS} \sim \frac{V_{OS}}{T} \cdot V_{BE}$), $T = 298K$ for $T_A = 25^{\circ}C$.
3. The initial zero offset voltage is established by adjusting the ratio of I_{C1} to I_{C2} at $T_A = 25^{\circ}C$. This ratio must be held to 0.003% over the entire temperature range. Measurements are taken at the temperature extremes and $25^{\circ}C$.
4. Guaranteed by design.

TYPICAL PERFORMANCE CHARACTERISTICS

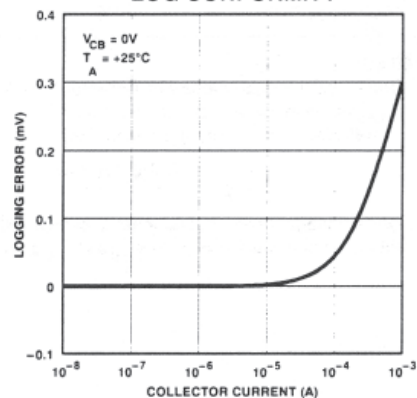
LOW FREQUENCY NOISE
(0.1 Hz TO 10 Hz)



NOISE FIGURE vs
COLLECTOR CURRENT



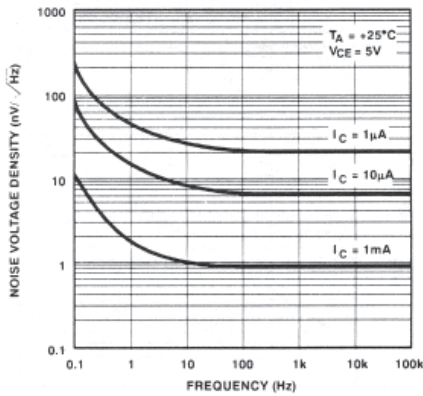
EMITTER-BASE
LOG CONFORMITY



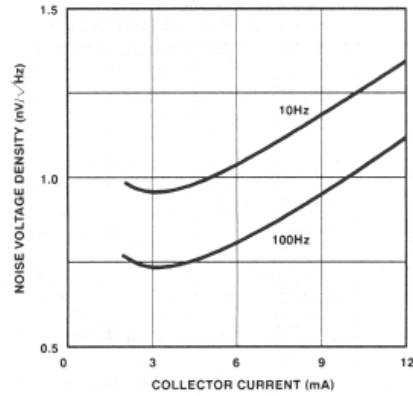
SSM2210—Typical Performance Characteristics

TYPICAL PERFORMANCE CHARACTERISTICS

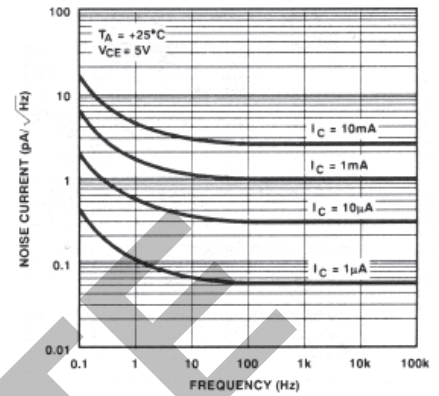
NOISE VOLTAGE DENSITY vs FREQUENCY



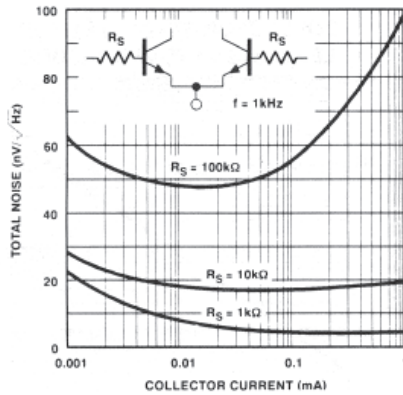
NOISE VOLTAGE DENSITY vs COLLECTOR CURRENT



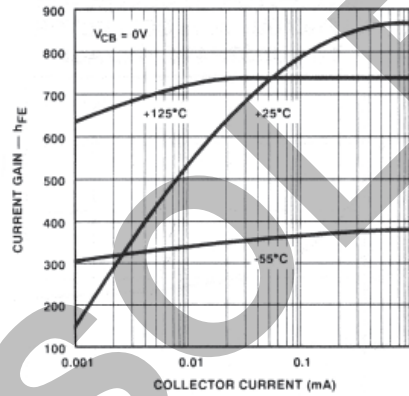
NOISE CURRENT DENSITY vs FREQUENCY



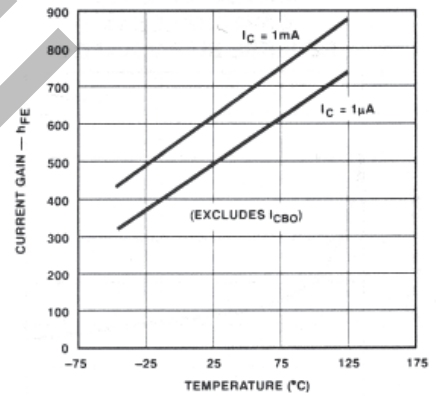
TOTAL NOISE vs COLLECTOR CURRENT



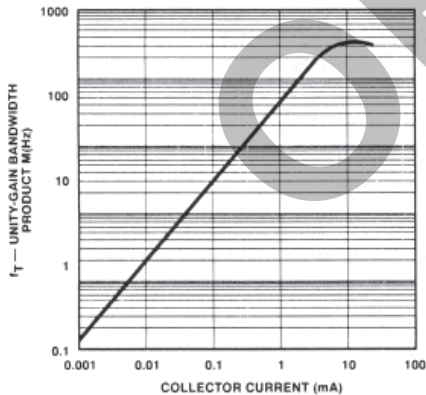
CURRENT GAIN vs COLLECTOR CURRENT



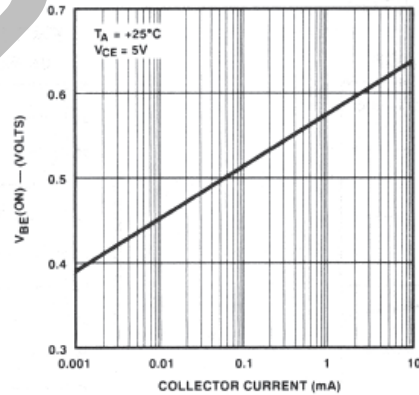
CURRENT GAIN vs TEMPERATURE



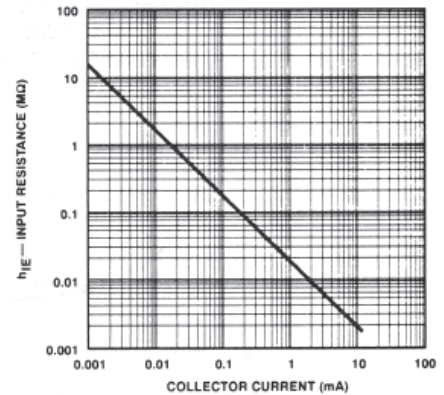
GAIN BANDWIDTH vs COLLECTOR CURRENT

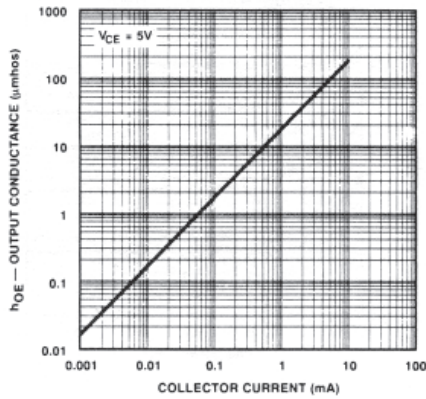
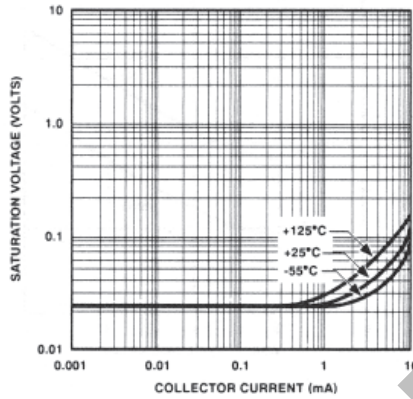
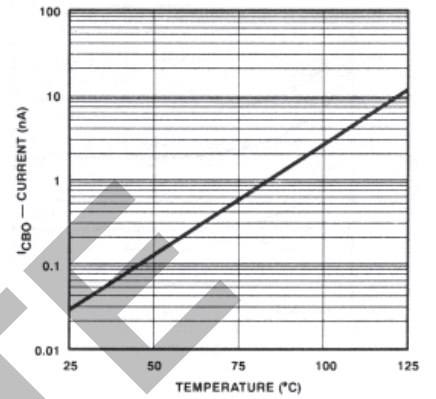
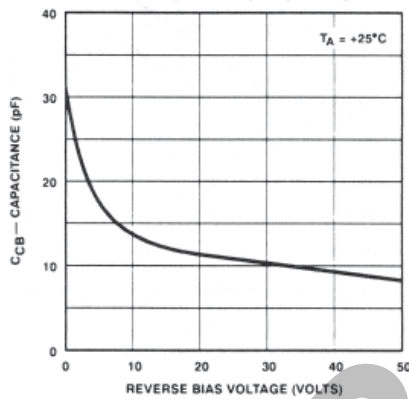
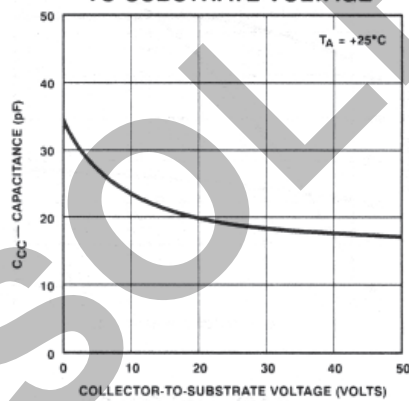
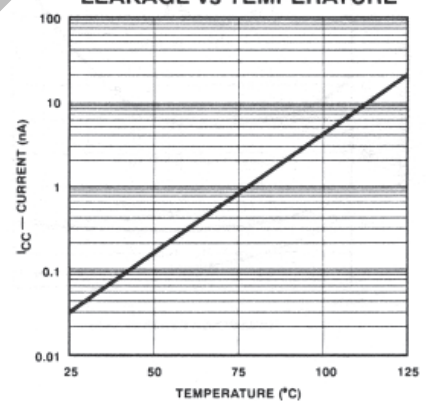
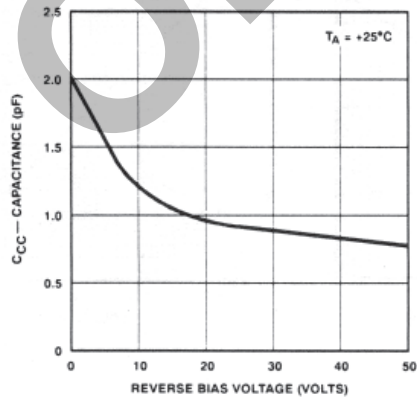
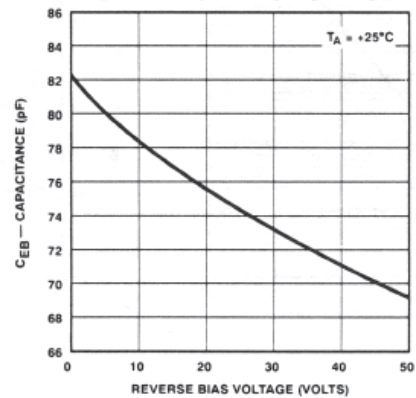


BASE-EMITTER-ON-VOLTAGE vs COLLECTOR CURRENT



SMALL-SIGNAL INPUT RESISTANCE vs COLLECTOR CURRENT



TYPICAL PERFORMANCE CHARACTERISTICS *Continued*SMALL-SIGNAL OUTPUT
CONDUCTANCE vs
COLLECTOR CURRENTSATURATION VOLTAGE
vs COLLECTOR CURRENTCOLLECTOR-TO-BASE
LEAKAGE vs TEMPERATURECOLLECTOR-BASE
CAPACITANCE vs
REVERSE BIAS VOLTAGECOLLECTOR-TO-COLLECTOR
CAPACITANCE vs COLLECTOR-
TO-SUBSTRATE VOLTAGECOLLECTOR-TO-COLLECTOR
LEAKAGE vs TEMPERATURECOLLECTOR-TO-COLLECTOR
CAPACITANCE vs
REVERSE BIAS VOLTAGEEMITTER-BASE CAPACITANCE
vs REVERSE BIAS VOLTAGE

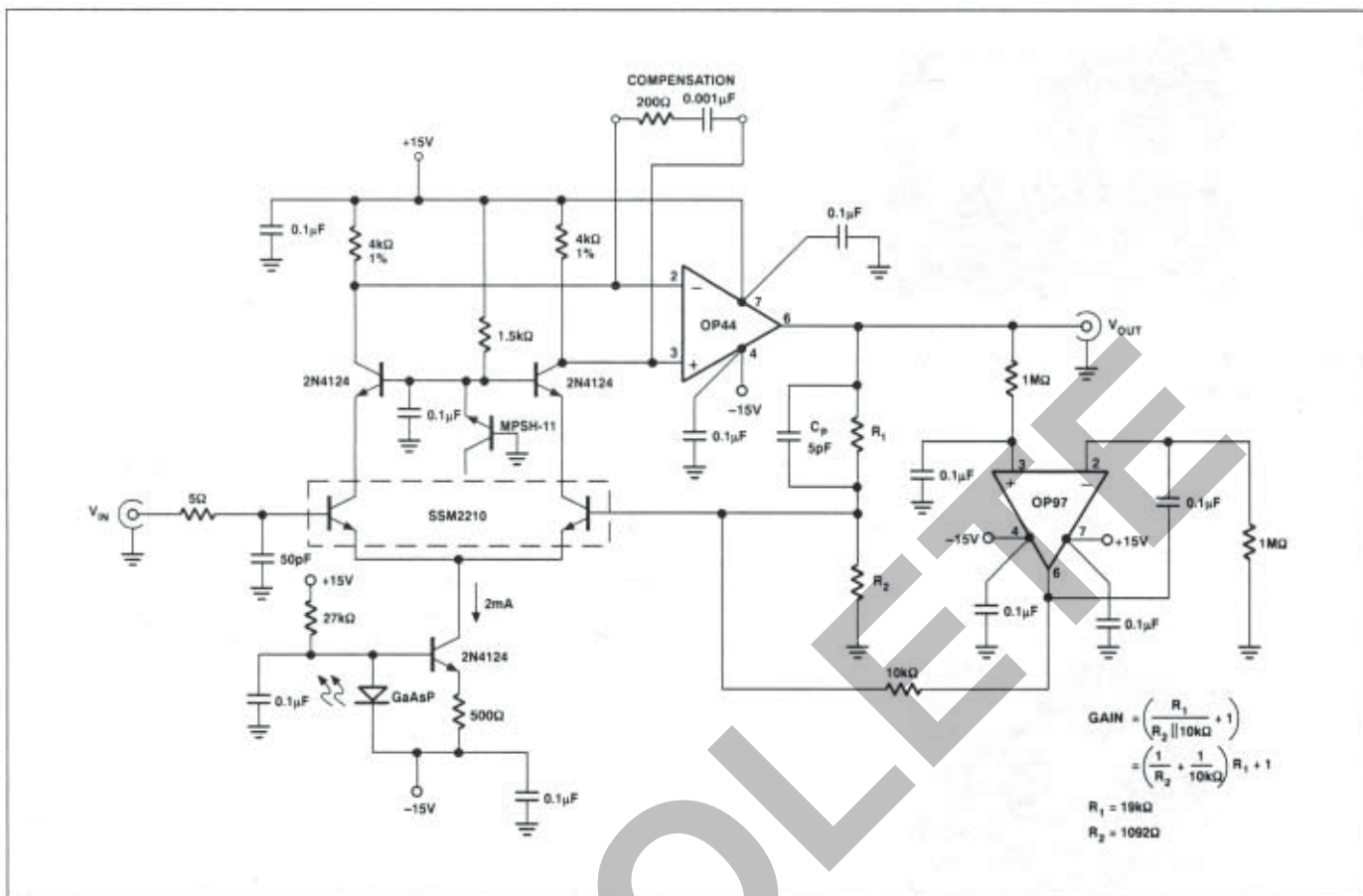


FIGURE 1: A Low-Noise Wideband Amplifier

A VERY LOW-NOISE, WIDEBAND AMPLIFIER

Figure 1 illustrates a low-noise, wide-band amplifier consisting of a high slew rate JFET amplifier, the OP44, and a cascoded differential preamplifier using the SSM2210 transistor pair. The SSM2210 achieves extremely low input voltage noise performance ($e_n \approx 0.7\text{nV}/\sqrt{\text{Hz}}$) via a large geometry transistor design which minimizes the base-spreading resistance. This, however, results in relatively higher collector-to-base capacitance (C_{OB}) than ordinary small-signal transistors. For high gain stages, the Miller effect of C_{OB} will limit the voltage gain bandwidth; resorting to a cascode configuration reduces the Miller feedback capacitance, improving stability, bandwidth, and reducing distortion due to base-width modulation. Additionally, cascoding

does not increase the noise figure of the overall amplifier system and reduces the high order harmonic distortion.

The circuit in Figure 1 balances the impedance symmetrically in the differential preamp. This serves to reject common-mode noise injected from the power supplies.

Although the SSM2210's transistors are closely matched, an offset voltage error can still be created by imbalanced source impedances. Accordingly, a precision low-power amplifier (OP-97), configured as a noninverting integrator is implemented which servos-out the offset voltage to less than $100\mu\text{V}$ referred to the input of the amplifier.

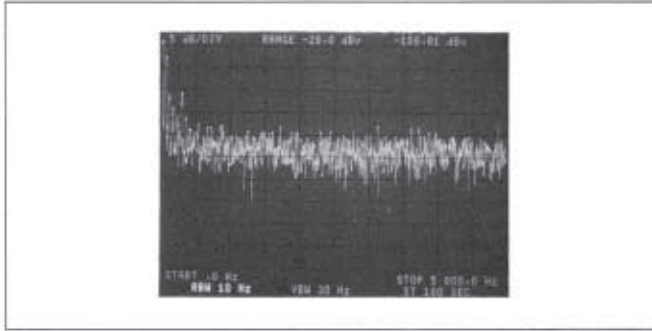


FIGURE 2: Spectrum Analyzer Display of Wideband Amplifier Noise Spectral Density. $e_n \approx 1.7\text{nV}/\sqrt{\text{Hz}}$

Figure 2 illustrates the composite amplifier's low voltage noise density of only $1.7\text{nV}/\sqrt{\text{Hz}}$ @ 1kHz. Figure 3 and Figure 4 show the excellent pulse response and an extremely low distortion of only 0.0015% over the audio bandwidth, respectively.

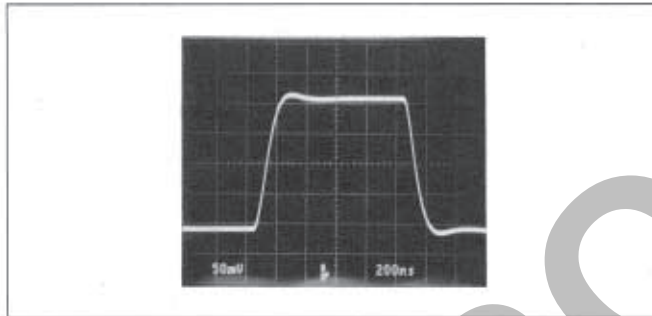


FIGURE 3: Small-Signal Pulse Response

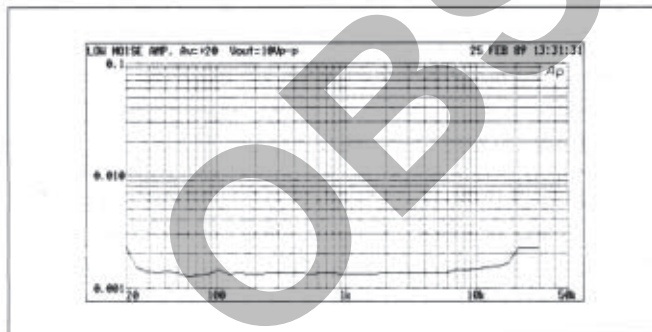


FIGURE 4: Total Harmonic Distortion vs Frequency

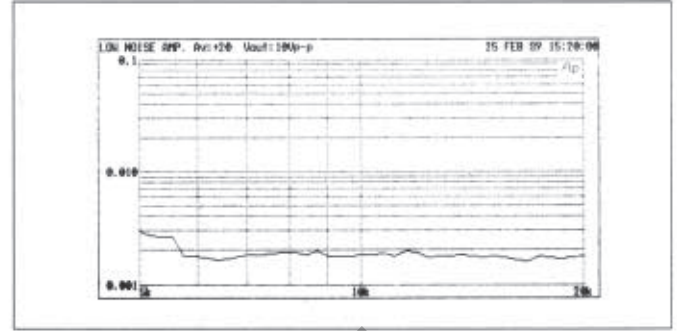


FIGURE 5: D.I.M. vs Frequency

A special test was performed to check for dynamic or transient intermodulation distortion. A square wave of 3.15kHz is mixed with a sine wave probe tone, and the resulting intermodulation distortion was found to be less than 0.002% (Figure 5). This is an impressively low value considering the amplifier's gain of 26dB. Interestingly, the GBW product of the composite amplifier was 63MHz which is much larger than that of the OP44 by itself. This is made possible by the SSM2210's cascaded preamplifier having a wide bandwidth and large signal gain.

The measured performance of this amplifier is summarized in Table 1.

TABLE 1: Measured Performance of the Low-Noise Wideband Amplifier

Slew-Rate	40V/ μs
Gain-Bandwidth	63.6 MHz
Input Noise Voltage Density @ 1kHz	$1.7\text{nV}/\sqrt{\text{Hz}}$
Output Voltage Swing	$\pm 13\text{V}$
Input Offset Voltage	10 μV

SSM2210

500pV/ $\sqrt{\text{Hz}}$ AMPLIFIER

In situations where low output, low-impedance transducers are used, amplifiers must have very low voltage noise to maintain a good signal-to-noise ratio. The design presented in this application is an operational amplifier with only 500pV/ $\sqrt{\text{Hz}}$ of broadband noise. The front end uses SSM2210 low-noise dual transistors to achieve this exceptional performance. The op amp has superb DC specifications compatible with high-precision transducer requirements, and AC specifications suitable for professional audio work.

PRINCIPLE OF OPERATION

The design configuration in Figure 6 uses an OP27 op amp (already a low-noise design) preceded by an amplifier consisting of three parallel-connected SSM2210 dual transistors. Base spreading resistance (rbb) generates thermal noise which is reduced by a factor of $\sqrt{3}$ when the input transistors are parallel connected. Schottky noise, the other major noise-generating mechanism, is minimized by using a relatively high collector current (1mA per device). High current ensures a low dynamic emitter resistance, but does increase the base current and its associated current noise. Higher current noise is relatively unimportant when low-impedance transducers are used.

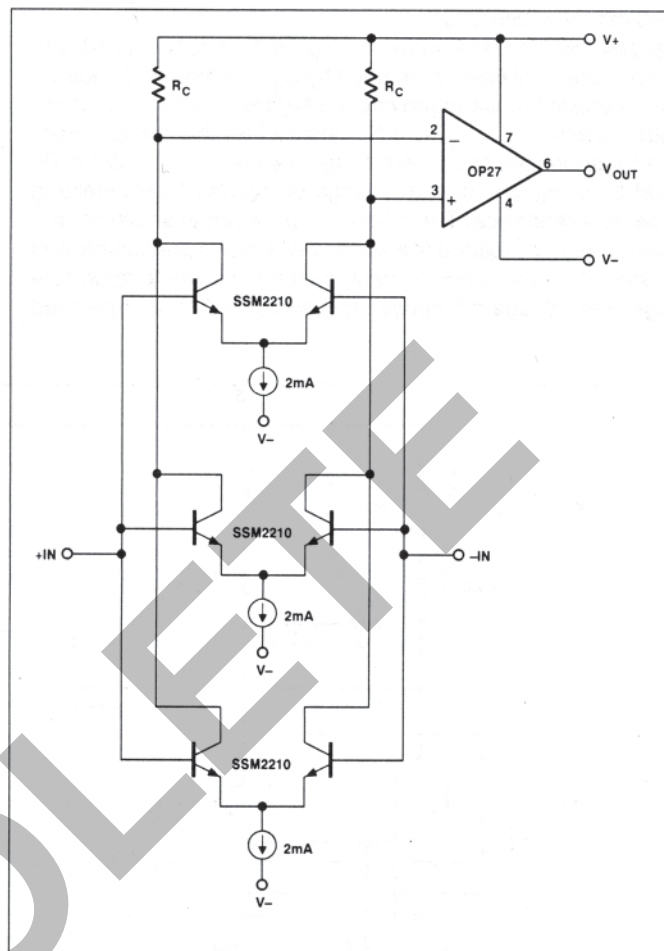


FIGURE 6: Simplified Schematic

CIRCUIT DESCRIPTION

The detailed circuit is shown in Figure 7. A total input-stage emitter current of 6mA is provided by Q_4 . The transistor acts as a true current source to provide the highest possible common-mode rejection. R_1 , R_2 , and R_3 ensure that this current splits equally among the three input pairs. The constant current in Q_4 is set by using the forward voltage of a GaAsP light-emitting diode as a reference. The difference between this voltage and the base-emitter voltage of a silicon transistor is predictable and constant (to within a few percent) over the military temperature range. The voltage difference, approximately 1V, is impressed

across the emitter resistor R_{12} which produces a temperature-stable emitter current.

R_6 and C_1 provide phase compensation for the amplifier and are sufficient to ensure stability at gains of ten and above.

R_7 is an input offset trim that provides approximately $\pm 300\mu\text{V}$ trim range. The very low drift characteristics of the SSM2210 make it possible to obtain drifts of less than $0.1\mu\text{V}/^\circ\text{C}$ when the offset is nulled close to zero. If this trim is not required, the R_4 , R_7 , and R_8 network should be omitted and R_5/R_9 connected directly to V_+ .

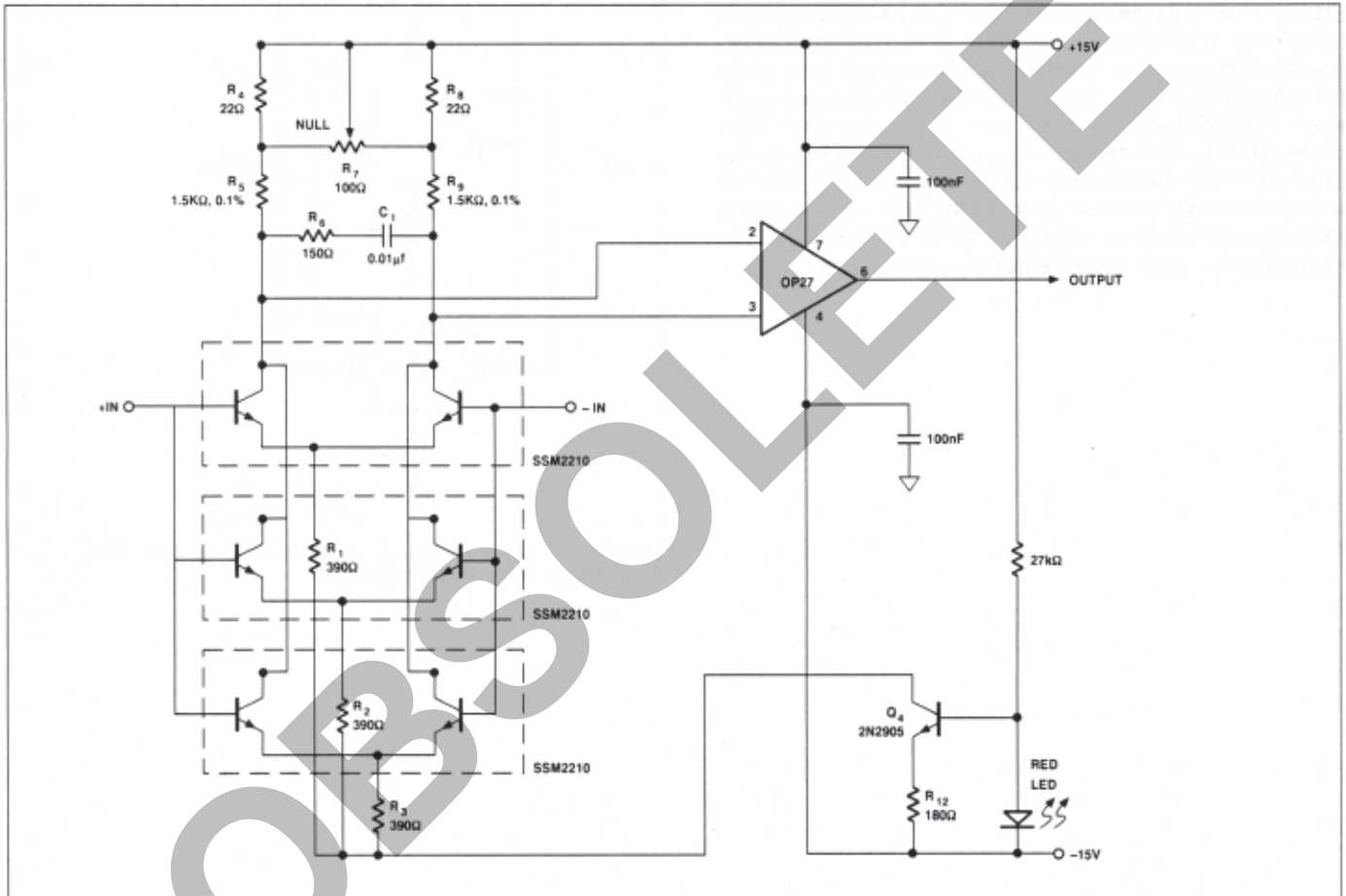


FIGURE 7: Complete Amplifier Schematic

SSM2210

AMPLIFIER PERFORMANCE

The measured performance of the op amp is summarized in Table 2. Figure 8 shows the broadband noise spectrum which is flat at about 500pV/√Hz. Figure 9 shows the low-frequency spectrum which illustrates the low 1/f noise corner at 1.5Hz. The low-frequency characteristic in the time domain from 0.1Hz to 10Hz is shown in Figure 10; peak-to-peak amplitude is less than 40nV.

TABLE 2: Measured Performance of the Op Amp

Input Noise		
Voltage Density at 1kHz		500pV/√Hz
Input Noise		
Voltage from 0.1Hz to 10Hz		40nV _{p-p}
Input Noise Current at 1kHz		
		1.5pA/√Hz
Gain-Bandwidth	G = 10	3MHz
	G = 100	600kHz
	G = 1000	150kHz
Slew Rate		2V/μs
Open-Loop Gain		3 × 10 ⁷
Common-Mode Rejection		130dB
Input Bias Current		3μA
Supply Current		10mA
Nulls TCV _{OS}		0.1μV/°C Max
T.H.D. at 1kHz	G = 1000	0.002%

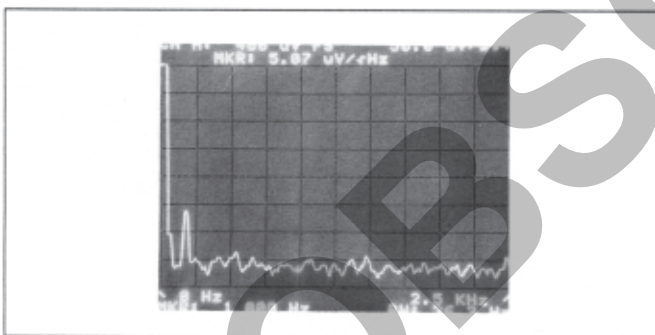


FIGURE 8: Spectrum Analyzer Display – Broadband

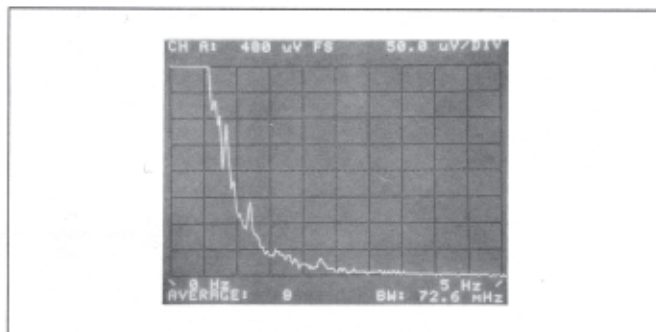


FIGURE 9: Spectrum Analyzer Display – Low Frequency

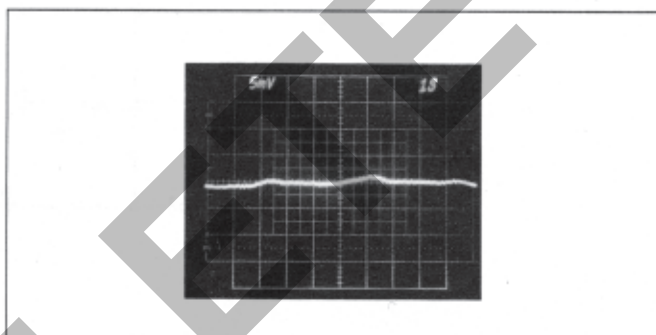


FIGURE 10: Oscilloscope Display

CONCLUSION

Using SSM2210 matched transistor pairs operating at a high current level, it is possible to construct a high-performance, low-noise operational amplifier. The circuit uses a minimum of components and achieves performance levels exceeding monolithic amplifiers.

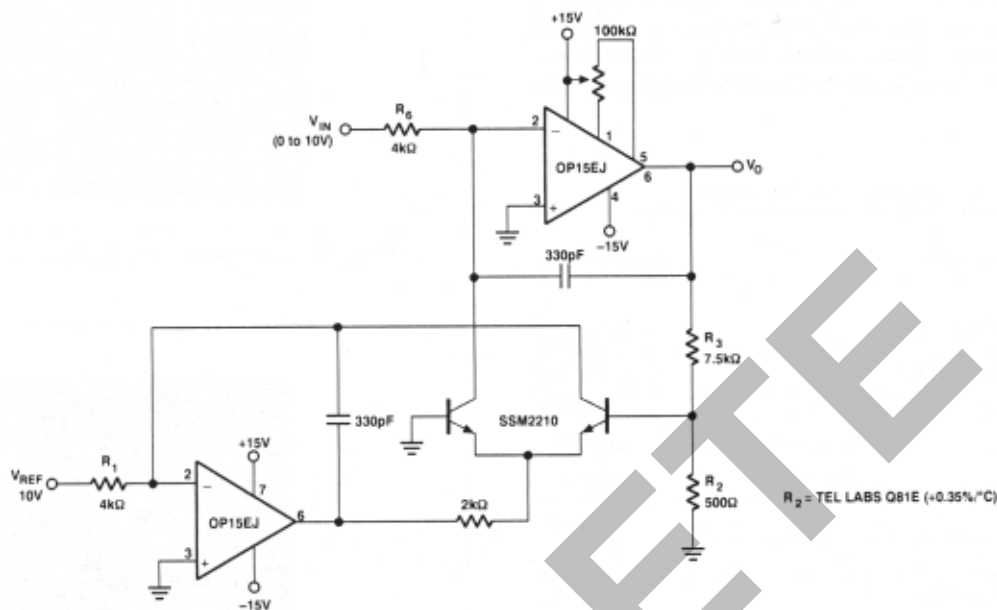


FIGURE 11: Fast Logarithmic Amplifier

FAST LOGARITHMIC AMPLIFIER

The circuit of Figure 11 is a modification of a standard logarithmic amplifier configuration. Running the SSM2210 at 2.5mA per side (full-scale) allows a fast response with wide dynamic range. The circuit has a 7 decade current range, a 5 decade voltage range, and is capable of 2.5μs settling time to 1% with a 1 to 10V step.

The output follows the equation:

$$V_O = \frac{R_3 + R_2}{R_2} \frac{kT}{q} \ln \frac{V_{REF}}{V_{IN}}$$

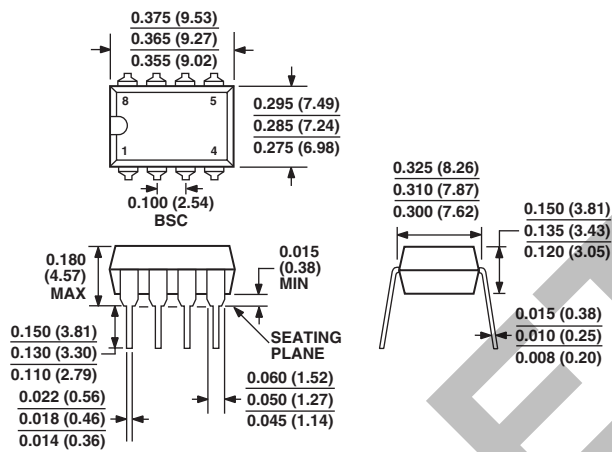
To compensate for the temperature dependence of the kT/q term, a resistor with a positive 0.35%/°C temperature coefficient is chosen for R_2 .

The output is inverted with respect to the input, and is nominally -1V/decade using the component values indicated.

OUTLINE DIMENSIONS

8-Lead Plastic Dual In-Line Package [PDIP]
[P-Suffix]
(N-8)

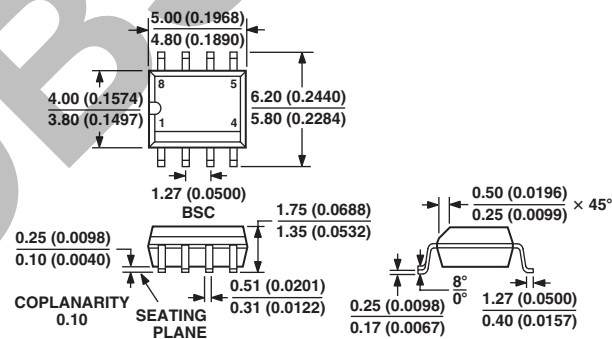
Dimensions shown in inches and (millimeters)



COMPLIANT TO JEDEC STANDARDS MO-095AA
CONTROLLING DIMENSIONS ARE IN INCHES; MILLIMETER DIMENSIONS
(IN PARENTHESES) ARE ROUNDED-OFF INCH EQUIVALENTS FOR
REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN

8-Lead Standard Small Outline Package [SOIC]
Narrow Body
[S-Suffix]
(R-8)

Dimensions shown in inches and (millimeters)



COMPLIANT TO JEDEC STANDARDS MS-012AA
CONTROLLING DIMENSIONS ARE IN MILLIMETERS; INCH DIMENSIONS
(IN PARENTHESES) ARE ROUNDED-OFF MILLIMETER EQUIVALENTS FOR
REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN

Revision History

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11/03—Data Sheet changed from REV. B to REV. C.	
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Updated OUTLINE DIMENSIONS	12